# 1981813-1 ACTIVE

#### Micro SLP

TE Internal #: 1981813-1

PCB Mount Receptacle, Wire-to-Board, 2 Position, .8 mm [.031 in] Centerline, Gold (Au), Surface Mount, Signal, Black, Tape & Reel

View on TE.com >

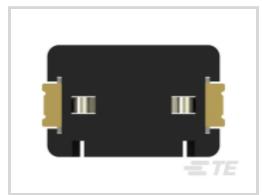


Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Type: PCB Mount Receptacle

Connector System: Wire-to-Board

Number of Positions: 2
Number of Rows: 1

Centerline (Pitch): .8 mm [ .031 in ]

### **Features**

### Product Type Features

Primary Product Color

Contact Base Material

**Contact Features** 

PCB Connector Type	PCB Mount Receptacle
Connector System	Wire-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly
Configuration Features	
Number of Positions	2
Number of Rows	1
Electrical Characteristics	
Operating Voltage	30 VAC
Body Features	

Black

Phosphor Bronze



Contact Mating Area Plating Material	Gold (Au)
Contact Type	Receptacle
Contact Current Rating (Max)	.5 A
Termination Features	
Termination Method to PCB	Surface Mount
Mechanical Attachment	
Mating Retention	Without
Mating Alignment Type	Polarization
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Mating Alignment	With
Housing Features	
Housing Material	LCP (Liquid Crystal Polymer)
Centerline (Pitch)	.8 mm[.031 in]
Dimensions	
Connector Height	2.85 mm
Profile Height from PCB	1.4 mm[.055 in]
Usage Conditions	
Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	4000
Packaging Method	Tape & Reel
Product Compliance	

### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant



China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## Compatible Parts



# Customers Also Bought

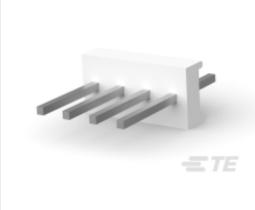








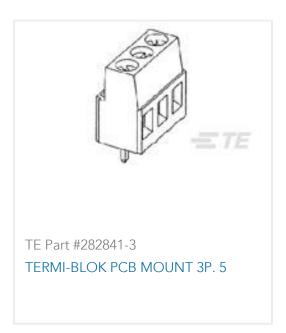














### **Documents**

### **Product Drawings**

**BRD CONN ASSY WITH EMBOSS** 

Japanese

### **CAD Files**

3D PDF

English

**Customer View Model** 

ENG\_CVM\_1981813-1\_A1.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_1981813-1\_A1.3d\_stp.zip

English

**Customer View Model** 

ENG\_CVM\_1981813-1\_A1.2d\_dxf.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### Datasheets & Catalog Pages

Products for Mobile Equipment

English

### **Product Specifications**

**Application Specification** 

Japanese